

RELIABILITY REPORT FOR MAX8526EUD+

PLASTIC ENCAPSULATED DEVICES

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MAXIM INTEGRATED

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Approved by
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Conclusion

The MAX8526EUD+ successfully meets the quality and reliability standards required of all Maxim Integrated products. In addition, Maxim Integrated's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim Integrated's quality and reliability standards.

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I. Device Description

A. General

.....Attachments

The MAX8526/MAX8527/MAX8528 low-dropout linear regulators operate from input voltages as low as 1.425V and are able to deliver up to 2A of continuous output current with a maximum dropout voltage of only 200mV. The output voltage can be set from 0.5V to (VIN - 0.2V) and is 1.4% accurate over load and line variations, from 0°C to +85°C. These regulators use small, 2.2µF ceramic input capacitors and 10µF ceramic output capacitors to deliver 2A output current. High bandwidth provides excellent transient response and limits the output voltage deviation to 45mV for a 20mA to 2A load step, with only a 10µF ceramic output capacitor, and the voltage deviations can be reduced further by increasing the output capacitor. Designed with an internal p-channel MOSFET pass transistor, the MAX8526/MAX8527/MAX8528 feature low 500µA typical supply current during dropout conditions. Soft-start reduces inrush current. Other features include a logic-controlled shutdown mode, short-circuit protection, and thermal-overload protection. The MAX8527 features a power-OK (POK) output that transitions high when the regulator output is within ±10% of its nominal output voltage. The MAX8528 features a 150ms power-on reset (POR) output. The parts are packaged in a 14-pin TSSOP package, which includes an exposed pad for optimal power dissipation.



1.425V to 3.6V Input, 2A, 0.2V Dropout LDO Regulators

II. Manufacturing Information

- A. Description/Function:
- B. Process:
- C. Number of Device Transistors:
- D. Fabrication Location:
- E. Assembly Location:
- F. Date of Initial Production: January 24, 2004

III. Packaging Information

A. Package Type:	14-pin TSSOP
B. Lead Frame:	Copper
C. Lead Finish:	100% matte Tin
D. Die Attach:	Conductive
E. Bondwire:	Au (1.3 mil dia.)
F. Mold Material:	Epoxy with silica filler
G. Assembly Diagram:	#05-9000-0164
H. Flammability Rating:	Class UL94-V0
I. Classification of Moisture Sensitivity per	Level 1
JEDEC standard J-STD-020-C	
J. Single Layer Theta Ja:	48°C/W
K. Single Layer Theta Jc:	3°C/W
L. Multi Layer Theta Ja:	39°C/W
M. Multi Layer Theta Jc:	3°C/W

IV. Die Information

A. Dimensions:	62X100 mils
B. Passivation:	Si_3N_4/SiO_2 (Silicon nitride/ Silicon dioxide)
C. Interconnect:	Al with Ti/TiN Barrier
D. Backside Metallization:	None
E. Minimum Metal Width:	Metal1 = 0.5 microns (as drawn)
F. Minimum Metal Spacing:	Metal1 = 0.45 microns (as drawn)
G. Bondpad Dimensions:	
H. Isolation Dielectric:	SiO ₂
I. Die Separation Method:	Wafer Saw

S4

California, Texas or Japan

Philippines, Thailand

I. Die Separation Method:



V. Quality Assurance Information

A. Quality Assurance Contacts:	Don Lipps (Manager, Reliability Engineering) Bryan Preeshl (Vice President of QA)
B. Outgoing Inspection Level:	0.1% for all electrical parameters guaranteed by the Datasheet. 0.1% for all Visual Defects.
C. Observed Outgoing Defect Rate:	< 50 ppm
D. Sampling Plan:	Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (λ) is calculated as follows:

$$\lambda = \underbrace{1}_{\text{MTTF}} = \underbrace{1.83}_{1000 \text{ x } 4340 \text{ x } 239 \text{ x } 2} \text{ (Chi square value for MTTF upper limit)}$$

$$\lambda = 0.88 \text{ x } 10^{-9}$$

$$\lambda = 0.88 \text{ F.I.T. (60\% confidence level @ 25°C)}$$

The following failure rate represents data collected from Maxim Integrated's reliability monitor program. Maxim Integrated performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at http://www.maximintegrated.com/qa/reliability/monitor. Cumulative monitor data for the S4 Process results in a FIT Rate of 0.04 @ 25C and 0.69 @ 55C (0.8 eV, 60% UCL).

B. E.S.D. and Latch-Up Testing (lot SAC0EZ017F, D/C 0523)

The PM64 die type has been found to have all pins able to withstand a HBM transient pulse of +/-1500V per JEDEC JESD22-A114. Latch-Up testing has shown that this device withstands a current of +/-250mA.



Table 1 Reliability Evaluation Test Results

MAX8526EUD+

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	COMMENTS
Static Life Test	(Note 1)				
	Ta = 135°C	DC Parameters	79	0	SAC0D2018D, D/C 0513
	Biased	& functionality	80	0	SAC0D2018E, D/C 0515
	Time = 1000 hrs.		80	0	SAK0BZ002C, D/C 0303

Note 1: Life Test Data may represent plastic DIP qualification lots